

# EB13E2H2H-25.000M

[Click part number to visit Part Number Details page](#)

## REGULATORY COMPLIANCE (Data Sheet downloaded on Dec 4, 2018)


[Click badges to download compliance docs](#)

Regulatory Compliance standards are subject to updates by governing bodies. Click the badges to download the latest compliance docs for this part number directly from Ecliptek.



## ITEM DESCRIPTION

Quartz Crystal Clock Oscillators XO (SPXO) LVCMOS (CMOS) 3.3Vdc 4 Pad 2.5mm x 3.2mm Ceramic Surface Mount (SMD) 25.000MHz  $\pm 50$ ppm over -40°C to +85°C

## ELECTRICAL SPECIFICATIONS

Nominal Frequency	25.000MHz
Frequency Tolerance/Stability	$\pm 50$ ppm Maximum over -40°C to +85°C (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, Shock, and Vibration)
Supply Voltage	3.3Vdc $\pm 5\%$
Input Current	5mA Maximum
Output Voltage Logic High (Voh)	90% of Vdd Minimum (IOH= -4mA)
Output Voltage Logic Low (Vol)	10% of Vdd Maximum (IOL= +4mA)
Rise/Fall Time	4nSec Maximum (Measured at 20% to 80% of waveform)
Duty Cycle	50 $\pm 5$ (%) (Measured at 50% of waveform)
Load Drive Capability	15pF Maximum
Output Logic Type	CMOS
Pin 1 Connection	Tri-State (High Impedance)
Tri-State Input Voltage (Vih and Vil)	80% of Vdd Minimum or No Connect to Enable Output, 20% of Vdd Maximum to Disable Output (High Impedance)
Standby Current	10 $\mu$ A Maximum (Disabled Output: High Impedance)
RMS Phase Jitter	1pSec Maximum (Fj = 12kHz to 20MHz)
Start Up Time	10mSec Maximum
Storage Temperature Range	-55°C to +125°C

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

ESD Susceptibility	MIL-STD-883, Method 3015, Class 1, HBM: 1500V
Fine Leak Test	MIL-STD-883, Method 1014, Condition A
Flammability	UL94-V0
Gross Leak Test	MIL-STD-883, Method 1014, Condition C
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Moisture Resistance	MIL-STD-883, Method 1004
Moisture Sensitivity	J-STD-020, MSL 1
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010, Condition B
Vibration	MIL-STD-883, Method 2007, Condition A

## EB13E2H2H-25.000M [Click part number to visit Part Number Details page](#)

### MECHANICAL DIMENSIONS (all dimensions in millimeters)



PIN	CONNECTION
1	Tri-State
2	Case/Ground
3	Output
4	Supply Voltage

LINE	MARKING
1	<b>E25.0</b> E=Ecliptek Designator
2	<b>XXXXX</b> XXXXX=Ecliptek Manufacturing Identifier

### Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are  $\pm 0.1$

# EB13E2H2H-25.000M [Click part number to visit Part Number Details page](#)

## OUTPUT WAVEFORM & TIMING DIAGRAM



# EB13E2H2H-25.000M

[Click part number to visit Part Number Details page](#)

## Test Circuit for CMOS Output



Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

# EB13E2H2H-25.000M

[Click part number to visit Part Number Details page](#)

## Recommended Solder Reflow Methods



### High Temperature Infrared/Convection

$T_s \text{ MAX}$ to $T_L$ (Ramp-up Rate)	$3^\circ\text{C/Second Maximum}$
---	----------------------------------

#### Preheat

- Temperature Minimum ( $T_s \text{ MIN}$ )	$150^\circ\text{C}$
- Temperature Typical ( $T_s \text{ TYP}$ )	$175^\circ\text{C}$
- Temperature Maximum ( $T_s \text{ MAX}$ )	$200^\circ\text{C}$
- Time ( $t_s \text{ MIN}$ )	60 - 180 Seconds

Ramp-up Rate ( $T_L$ to $T_P$ )	$3^\circ\text{C/Second Maximum}$
---------------------------------	----------------------------------

#### Time Maintained Above:

- Temperature ( $T_L$ )	$217^\circ\text{C}$
- Time ( $t_L$ )	60 - 150 Seconds

Peak Temperature ( $T_P$ )	$260^\circ\text{C Maximum for 10 Seconds Maximum}$
----------------------------	--

Target Peak Temperature ( $T_P \text{ Target}$ )	$250^\circ\text{C} +0/-5^\circ\text{C}$
--	---

Time within $5^\circ\text{C}$ of actual peak ( $t_p$ )	20 - 40 Seconds
--	-----------------

Ramp-down Rate	$6^\circ\text{C/Second Maximum}$
----------------	----------------------------------

Time $25^\circ\text{C}$ to Peak Temperature (t)	8 Minutes Maximum
---	-------------------

Moisture Sensitivity Level	Level 1
----------------------------	---------

# EB13E2H2H-25.000M

[Click part number to visit Part Number Details page](#)

## Recommended Solder Reflow Methods



### Low Temperature Infrared/Convection $240^\circ\text{C}$

$T_s$ MAX to $T_L$ (Ramp-up Rate)	$5^\circ\text{C}/\text{Second}$ Maximum
<b>Preheat</b>	
- Temperature Minimum ( $T_s$ MIN)	N/A
- Temperature Typical ( $T_s$ TYP)	$150^\circ\text{C}$
- Temperature Maximum ( $T_s$ MAX)	N/A
- Time ( $t_s$ MIN)	60 - 120 Seconds
Ramp-up Rate ( $T_L$ to $T_P$ )	$5^\circ\text{C}/\text{Second}$ Maximum
<b>Time Maintained Above:</b>	
- Temperature ( $T_L$ )	$150^\circ\text{C}$
- Time ( $t_L$ )	200 Seconds Maximum
Peak Temperature ( $T_P$ )	$240^\circ\text{C}$ Maximum
Target Peak Temperature ( $T_P$ Target)	$240^\circ\text{C}$ Maximum 2 Times / $230^\circ\text{C}$ Maximum 1 Time
Time within $5^\circ\text{C}$ of actual peak ( $t_p$ )	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
Ramp-down Rate	$5^\circ\text{C}/\text{Second}$ Maximum
Time $25^\circ\text{C}$ to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1

### Low Temperature Manual Soldering

$185^\circ\text{C}$  Maximum for 10 Seconds Maximum, 2 times Maximum.

### High Temperature Manual Soldering

$260^\circ\text{C}$  Maximum for 5 Seconds Maximum, 2 times Maximum.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Standard Clock Oscillators](#) category:*

*Click to view products by [Ecliptek](#) manufacturer:*

Other Similar products are found below :

[EP1400SJTSC-125.000M](#) [601137](#) [601252](#) [CSX750FBC-24.000M-UT](#) [CSX750FBC-33.333M-UT](#) [CSX750FCC-3.6864M-UT](#) [F335-12](#) [F335-25](#) [DSC506-03FM2](#) [ASA-20.000MHZ-L-T](#) [ASA-25.000MHZ-L-T](#) [ASA-27.000MHZ-L-T](#) [ASV-20.000MHZ-LR-T](#) [ECS-2018-160-BN-TR](#) [EL13C7-H2F-125.00M](#) [MXO45HS-2C-66.6666MHZ](#) [SiT1602BI-22-33E-50.000000E](#) [SIT8003AC-11-33S-2.04800X](#) [SiT8256AC-23-33E-156.250000X](#) [SIT8918AA-11-33S-50.000000G](#) [SM4420TEV-40.0M-T1K](#) [F335-24](#) [F335-40](#) [F335-50](#) [F535L-10](#) [F535L-12](#) [F535L-16](#) [F535L-27](#) [F535L-48](#) [PE7744DW-100.0M](#) [CSX750FBC-20.000M-UT](#) [CSX-750FBC33333000T](#) [CSX750FBC-4.000M-UT](#) [CSX750FBC-7.3728M-UT](#) [CSX750FBC-8.000M-UT](#) [CSX-750FCC14745600T](#) [CSX750FCC-16.000M-UT](#) [CSX-750FCC40000000T](#) [CSX750FCC-4.000M-UT](#) [ASA-22.000MHZ-L-T](#) [ASA2-26.000MHZ-L-T](#) [ASA-40.000MHZ-L-T](#) [ASA-48.000MHZ-L-T](#) [ASA-60.000MHZ-L-T](#) [ASF1-3.686MHZ-N-K-S](#) [XO37CTECNA10M](#) [XO57CRECNA16M](#) [XO57CTECNA3M6864](#) [XO57CTECNA4M9152](#) [DSC400-0333Q0032KE1-EVB](#)